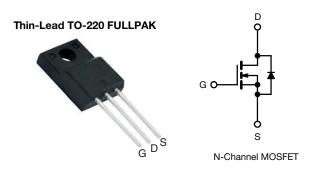
SiHA21N65EF

www.vishay.com

Vishay Siliconix

E Series Power MOSFET with Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.18				
Q _g max. (nC)	106				
Q _{gs} (nC)	14				
Q _{gd} (nC)	33				
Configuration	Single				

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
- Server and telecom power supplies
- Lighting
- High-intensity discharge (HID) Fluorescent ballast lighting
- Consumer and computing
- ATX power supplies
- Industrial
- Welding
 - Battery chargers
- Renewable energy
 Solar (PV inverters)
- Switch mode power supplies (SMPS)
- Applications using the following topologies
 - LCC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free	SiHA21N65EF-E3				
Lead (Pb)-free and halogen-free	SiHA21N65EF-GE3				

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	650	- V	
Gate-source voltage			V _{GS}	± 30		
Continuous drain ourrant $(T_{1} - 150 ^{\circ}\text{C})^{\circ}$	$V_{GS} \text{ at } 10 \text{ V} \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	I	21			
Continuous drain current (T _J = 150 °C) ^e	VGS at 10 V	T _C = 100 °C	I _D	13	А	
Pulsed drain current ^a			I _{DM}	53		
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	367	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$T_J = T_J$	125 °C	d\//dt	37	V/ns	
Reverse diode dV/dt ^d			dV/dt	31	V/ns	
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

S17-1308-Rev. D, 21-Aug-17



COMPLIANT

HALOGEN FREE



www.vishay.com

Vishay Siliconix

PARAMETER	SYMBOL	TYP.	1	MAX.			UNIT		
						UNII			
Maximum junction-to-ambient	R _{thJA}	- 65			°C/W				
Maximum junction-to-case (drain)	R _{thJC}	- 3.6							
SPECIFICATIONS (T _J = 25 °C, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNI		
Static		1			•	1	1		
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		650	-	-	V		
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.67	-	V/°0	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2	-	4	V	
			$V_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA	
Zero gate voltage drain current	1	V _{DS} =	= 520 V, V _G	S = 0 V	-	-	1	μA	
zero gate voltage drain current	IDSS	V _{DS} = 520 \	/, V _{GS} = 0 V	′, T _J = 125 °C	-	-	500		
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	١c	₀ = 11 A	-	0.15	0.18	Ω	
Forward transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 11 A		-	7.0	-	S		
Dynamic					-	-	-		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2322	-	pF		
Output capacitance	C _{oss}			-	105	-			
Reverse transfer capacitance	C _{rss}			-	4	-			
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	84	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	293	-			
Total gate charge	Qg	V _{GS} = 10 V I _D = 11 A, V _{DS} = 520 V		-	71	106	nC		
Gate-source charge	Q _{gs}			-	14	-			
Gate-drain charge	Q _{gd}				-	33	-		
Turn-on delay time	t _{d(on)}				-	22	44		
Rise time	t _r	V _{DD} =	V_{DD} = 520 V, I_D = 11 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	34	68	ns	
Turn-off delay time	t _{d(off)}	V _{GS} =			-	68	102		
Fall time	t _f			-	42	84]		
Gate input resistance	R _g	f = 1 MHz, open drain		-	0.78	-	Ω		
Drain-Source Body Diode Characteristi	cs								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	^		
Pulsed diode forward current	I _{SM}			-	-	53	A		
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 11 A	, V _{GS} = 0 V	-	0.9	1.2	V	
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _S = 11 A, dl/dt = 100 A/μs, V _B = 25 V		-	160	-	ns		
Reverse recovery charge	Q _{rr}			-	1.2	-	μΟ		
Reverse recovery current	I _{RRM}		$ui/at = 100 \text{ A}/\mu \text{s}, \text{ V}_{\text{R}} = 25 \text{ V}$		-	14	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

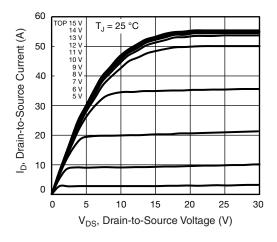


Fig. 1 - Typical Output Characteristics

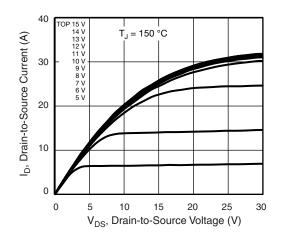
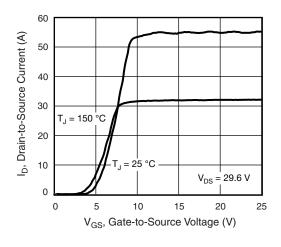


Fig. 2 - Typical Output Characteristics





S17-1308-Rev. D, 21-Aug-17

3 R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 10 V 1 V_{GS} 0.5 0 - 60 - 40 -20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

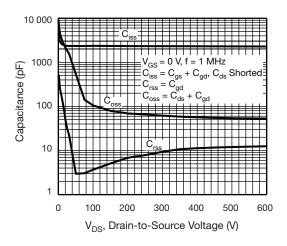


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

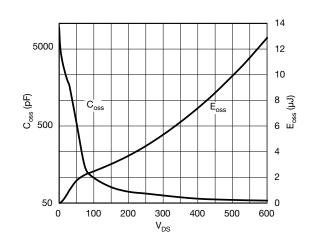


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

³ For technical questions, contact: <u>hvm@vishay.com</u>



24 V_{DS} = 520 V V_{GS}, Gate-to-Source Voltage (V) $V_{DS} = 325 V$ 20 V_{DS} = 130 V = 16 12 8 4 0 0 30 60 90 120 150 Q_q, Total Gate Charge (nC)

Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

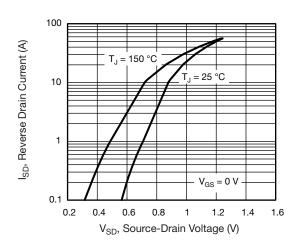


Fig. 8 - Typical Source-Drain Diode Forward Voltage

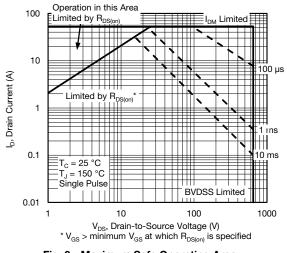


Fig. 9 - Maximum Safe Operating Area

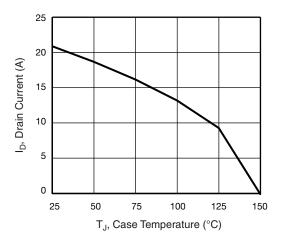


Fig. 10 - Maximum Drain Current vs. Case Temperature

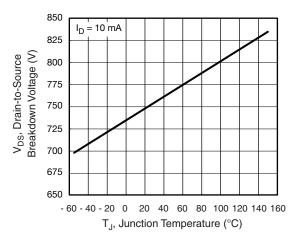


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

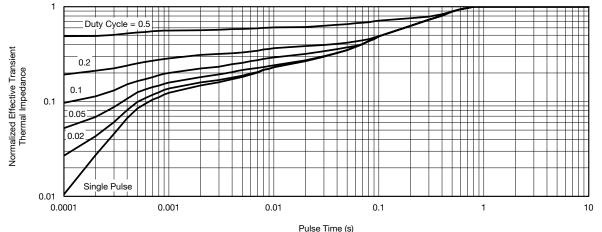
SiHA21N65EF

Vishay Siliconix



SiHA21N65EF

Vishay Siliconix



Puise Time (s)



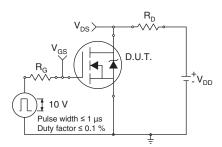


Fig. 13 - Switching Time Test Circuit

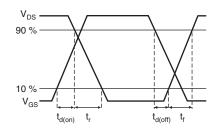


Fig. 14 - Switching Time Waveforms

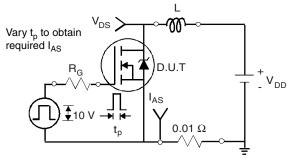


Fig. 15 - Unclamped Inductive Test Circuit

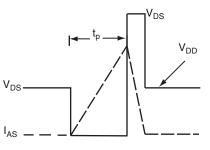


Fig. 16 - Unclamped Inductive Waveforms

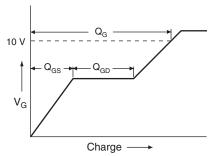


Fig. 17 - Basic Gate Charge Waveform

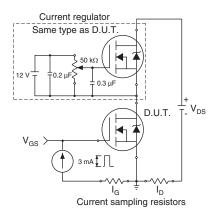


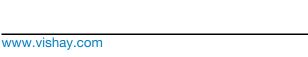
Fig. 18 - Gate Charge Test Circuit

S17-1308-Rev. D, 21-Aug-17

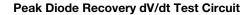
5

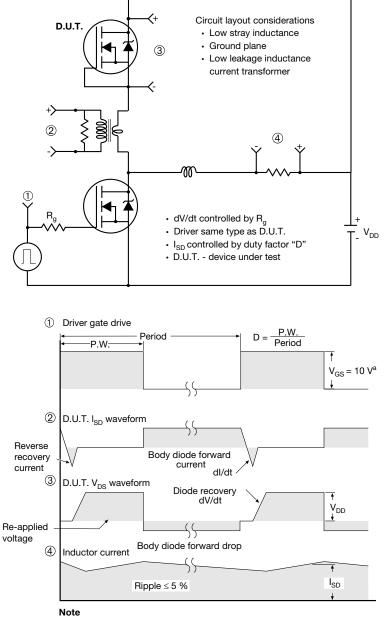
Document Number: 91772

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix





a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91722.

SHAY



Vishay Siliconix

TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.